AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

Complete Listing of Claims:

- 1. Canceled
- 2. (Previously Presented) A biocidal composition comprising composite particles, each of said composite particles containing a shell and a core, said core containing surface oxidized copper powder or a copper-containing compound selected from the group consisting of cuprous oxide, copper hydroxide, copper containing salt(s), and combinations thereof, and said shell containing a copper pyrithione formed by reaction of pyrithione acid or a water-soluble salt of pyrithione with a portion of said core copper or copper containing compound.
- 3. (Previously Presented) The composition of claim 2 which is produced by reacting a copper compound selected from the group consisting of cuprous sulfide, copper thiocyanate, and combinations thereof, with a pyrithione compound selected from the group consisting of pyrithione acid, ammonium pyrithione, tert-butylamine pyrithione, calcium pyrithione, dithiobis (pyridine-N-oxide), a magnesium salt adduct of dithiobis (pyridine-N-oxide) and combinations thereof, and sodium pyrithione, potassium pyrithione, lithium pyrithione, and combinations thereof, to cause <u>partial</u> transchelation of said pyrithione compound to copper pyrithione.
- 4. (Currently Amended) The composition of claim 2 wherein said copper-powder or copper containing compound is present in said composition in an amount of from about 99 to about 60% by weight, based upon the total weight of said composition, and

wherein the copper pyrithione and the copper or copper containing compound are present within a weight range of rations of from 1:20 to 20:1 of copper pyrithione relative to the copper or copper containing compound.

- 5. (Original) The composition of claim 3 wherein said copper-containing composite is present in said composition in an amount of from about 98 to about 80% by weight, based upon the total weight of said composition.
- 6. (Original) The composition of claim 4 wherein said copper-containing composite is present in said composition in an amount of from about 97 to about 86% by weight, based upon the total weight of said composition.
- 7. (Currently Amended) The composition of claim 2 wherein said copper pyrithione adduct shell is present in an amount of from about 1 to about 40% by weight, based upon the total weight of said composition.
- 8. (Currently Amended) The composition of claim 6 wherein said copper pyrithione adduct shell comprises from about 2 to about 20% by weight, based on the total weight of said composition.
- 9. (Currently Amended) The composition of claim 7 wherein said copper pyrithione adduct shell comprises from about 3 to about 14% by weight, based on the total weight of said composition.
- 10. (Original) The composition of claim 2, further comprising surfactant or a fatty acid coating on said particle of said copper-containing salt.
- 11. (Original) The composition of claim 10 wherein said fatty acid is selected from the group consisting of stearic, oleic, glycerol, and combinations thereof.

Claims 12 – 34 (Canceled)

- 35. (Currently amended) The composition of claim 2 wherein the core material is copper I oxide and the coating material shell is copper II pyrithione.
- 36. (Original) The composition of claim 35 wherein the weight ratio of copper oxide to copper pyrithione is from 5:1 to 15:1. and the coating a coating diameter is about 1% of the idealized spherical particle.
- 37. (Currently Amended) The composition of claim 36 wherein the weight ratio of copper oxide to copper pyrithione is about 10:1 and the diameter of the coating material shell is about one percent of the diameter of each of said composite particle as calculated for said composite particles being idealized spheres.
 - 38. (Canceled)
 - 39. (Canceled)
- 40. (New) The composition of claim 2, wherein the copper pyrithione and the copper or copper-containing compound are present within a weight range of ratios from 1:20 to 20:1 of copper pyrithione relative to the copper or copper-containing compound.